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# SH7145F

## Synchronous Serial Data Transmission/Reception

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### Summary

The SH7144 series is a single-chip microprocessor based on the SH-2 RISC (Reduced Instruction Set Computer) CPU core and integrating a number of peripheral functions.

This application note describes synchronous serial data transmission/reception using the SCI (Serial Communication Interface) module of the SH7145F. It is intended to be used as reference by users designing software applications.

The program examples contained in this application note have been tested. However, operation should be confirmed before using them in an actual application.

### Device for Which Operation Has Been Confirmed

SH7145F

### Contents

1. Specifications .....	2
2. Functions Used .....	3
3. Operation.....	6
4. Software .....	8
5. Flowcharts.....	11
6. Program Listing .....	14

## 1. Specifications

As shown in figure 1, synchronous serial data transmission and reception is performed using channel 1 (ch1) of the SCI module of the SH7145F. In this task example 3 bytes of serial data are transmitted from the SH7145, and serial data sent from the MCU, the transfer target, is received.

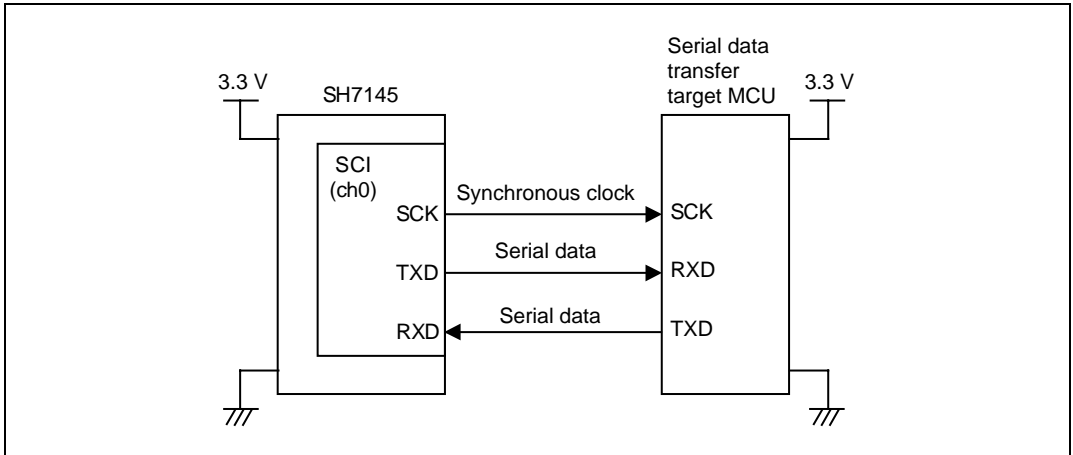


Figure 1 Synchronous Serial Data Transmission/Reception by SH7145

## 2. Functions Used

In this task example the SCI (Serial Communication Interface) is used to perform synchronous serial data transmission. Figure 2 shows a block diagram of channel 0 (ch0) of the SCI module. The functions of the elements shown in figure 2 are described below.

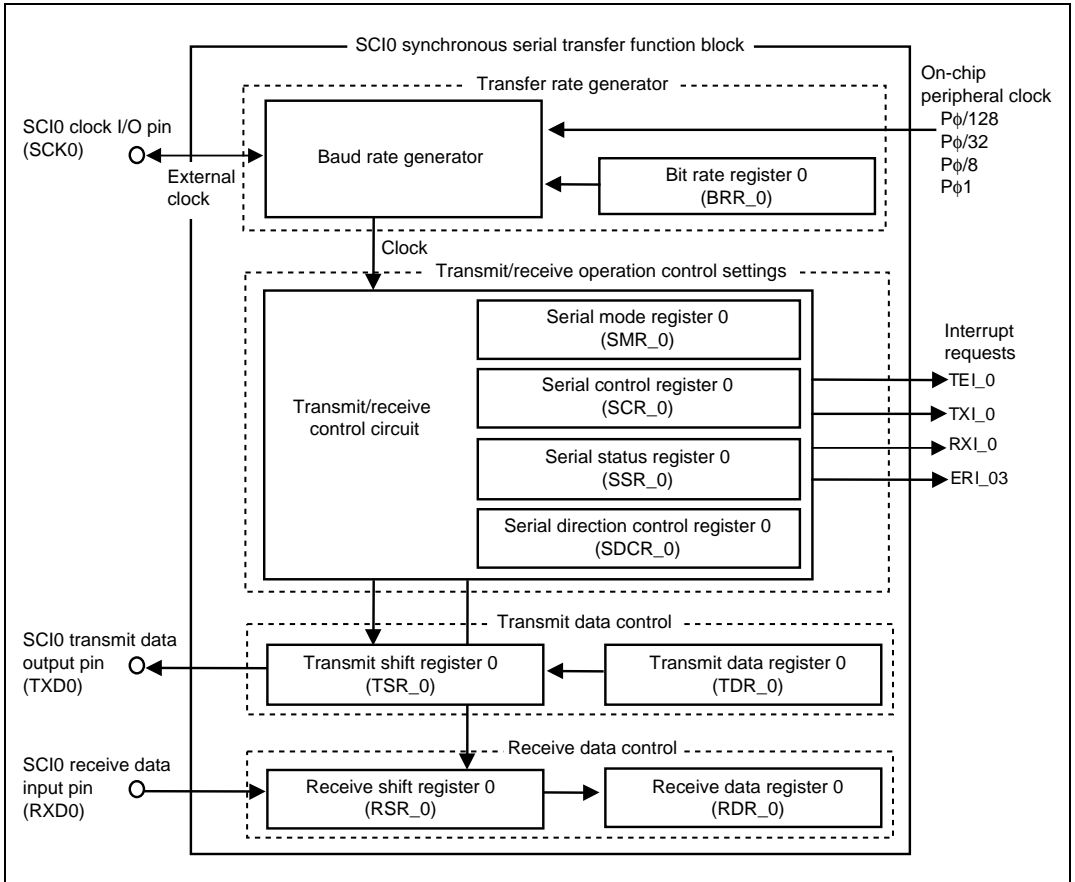


Figure 2 SCI (ch0) Block Diagram

- Synchronous Mode

Data is transmitted and received in synchronization with clock pulses. The transfer data length is fixed at 8 bits.

- On-Chip Peripheral Clock Pφ

This is the reference clock for operation of on-chip peripheral functions. The clock signal is generated by a clock oscillator.

- **Receive Shift Register (RSR\_0)**  
This register is used to receive serial data. Serial data is input to RSR\_0 from the RxD\_0 pin. When one frame of data has been received, it is automatically transferred to the receive data register (RDR\_0). RSR\_0 cannot be accessed by the CPU.
- **Receive Data Register (RDR\_0)**  
Received data is stored in this 8-bit register. When one frame of data has been received, it is automatically transferred from RSR\_0. RSR\_0 and RDR\_0 are in a double-buffer configuration, allowing continuous reception of data. RDR\_0 is a receive-only register, so it can only be read by the CPU.
- **Transmit Shift Register (TSR\_0)**  
This register is used to transmit serial data. In order to transmit data, the data is first transferred from the transmit data register (TDR\_0) to TSR\_0. Then the transmit data is output from the TxD\_0 pin. TSR\_0 cannot be accessed directly by the CPU.
- **Transmit Data Register (TDR\_0)**  
Data to be transmitted is stored in this 8-bit register. When it is detected that TDR\_0 is empty, data that has been written to TDR\_0 is automatically transferred to TSR\_0. TDR\_0 and TSR\_0 are in a double-buffer configuration. This allows data to be transferred to TSR\_0 after one frame of data has been transmitted and the next frame of data is still being written to TDR\_0, making possible continuous transmission of data. It is always possible to read or write to the TDR from the CPU, but before writing to the TDR it should be confirmed that the value of the TDRE bit in the serial status register (SSR\_0) is 1.
- **Serial Mode Register (SMR\_0)**  
This 8-bit register is used to select the serial data communication format and the clock source for the on-chip baud rate generator.
- **Serial Control Register (SCR\_0)**  
This register is used for transmit and receive control, interrupt control, and to select the transmit and receive clock source.
- **Serial Status Register (SSR\_0)**  
This register comprises the SCI0 status flag and the transmit and receive multiprocessor bits. TDRE, RDRF, ORER, PER, and FER can be cleared only.
- **Serial Direction Control Register (SDCR\_0)**  
This register is used to select whether the LSB or MSB is first. For 8-bit communication either LSB-first or MSB-first may be selected, but LSB-first should be used for 7-bit communication.
- **Bit Rate Register (BRR\_0)**  
This 8-bit register is used to adjust the bit rate. The SCI has independent baud rate generators for the individual channels, allowing different bit rates to be set for each. See the hardware manual for details on setting values, execution rate relationships, etc.

Table 1 shows the function allocations for the task example.

**Table 1 Function Allocations**

Function	Classification	Function Allocation
SCK0	Pin	Channel 0 synchronous clock I/O
TXD0	Pin	Channel 0 transmit data output pin
RXD0	Pin	Channel 0 transmit data input pin
SMR_0	SCI0	Sets communication format to synchronous mode
SCR_0	SCI0	Enables transmit operation
SSR_0	SCI0	Status flag showing SCI0 operation status
SDCR_0	SCI0	Specifies LSB-first
BRR_0	SCI0	Sets communication bit rate
TSR_0	SCI0	Register for transmitting serial data
TDR_0	SCI0	Register for storing transmit data

### 3. Operation

Figure 3 shows the operation of synchronous mode data transmission in the task example. To help explain figure 3, table 2 lists the software and hardware processing that is performed.

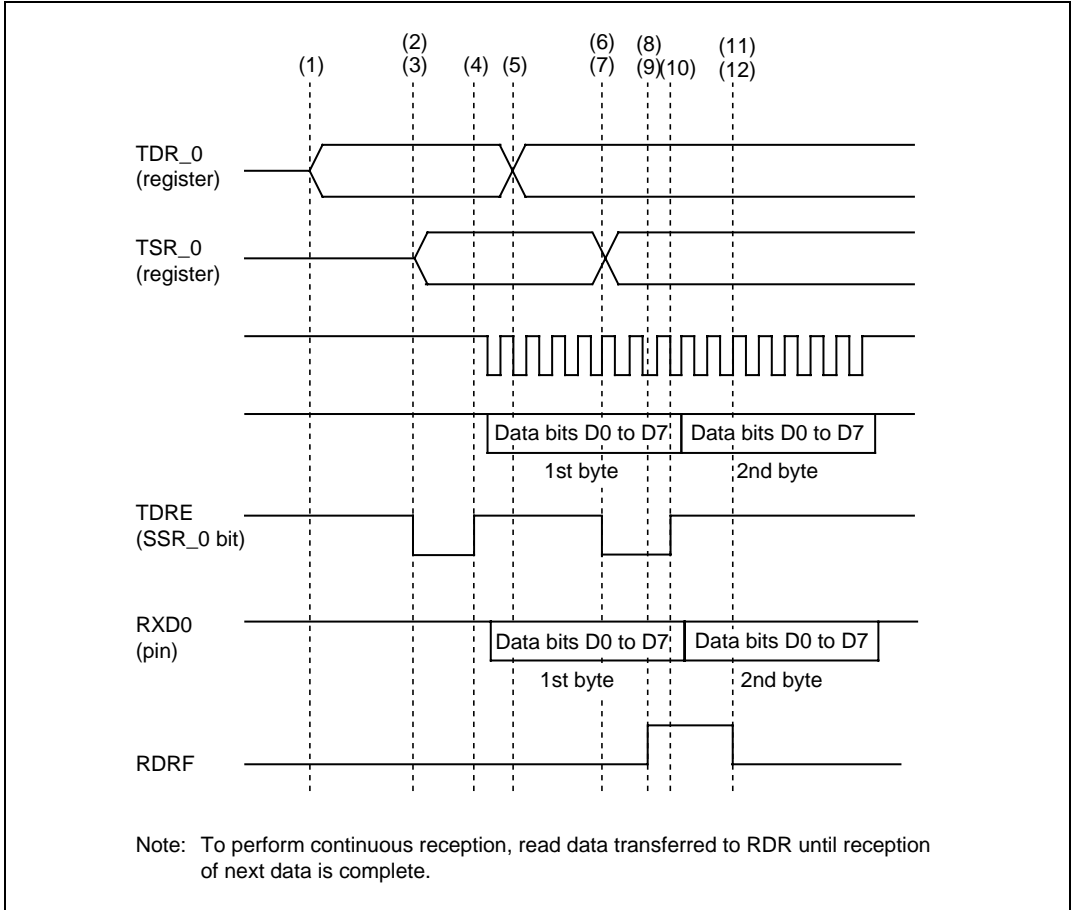


Figure 3 Data Transmission Operation



**Table 2 Processing**

	<b>Software Processing</b>	<b>Hardware Processing</b>
(1)	Write transmit data to TDR_0	—
(2)	Clear TDRE flag in SSR_0 to 0	—
(3)	—	Transfer data from TDR_0 to TSR_0
(4)	—	Set TDRE flag in SSR_0 to 0 and output transmit data from pin TXD0
(5)	Confirm TDRE is 0 and send next transmit data to TDR_0	—
(6)	Clear TDRE flag in SSR_0 to 0	—
(7)	—	Transfer data from TDR_0 to TSR_0
(8)	—	RSR_0 receives serial data and transfers it to RDR_0
(9)	—	Set RDRF flag to 1
(10)	—	When output of previous data finishes, set TDRE flag in SSR_0 to 1 and output transfer data from pin TXD0
(11)	Read data from RDR_3	—
(12)	Clear RDRF flag in SSR_3 to 0	—
(13)	Repeat	Repeat

## 4. Software

### (1) Module Descriptions

Table 3 lists the modules used in the task example.

**Table 3 Module Descriptions**

Module	Label	Function
Main routine	main	Calls modules
SCI routine	init_sci	Initial settings of SCI0
Transmit routine	trans_sci	Transmits serial data
Receive routine	rcv_sci	Receives serial data
Error handling	err_int	Handles receive errors

### (2) Argument Descriptions

Table 4 lists the arguments used in the task example.

**Table 4 Argument Descriptions**

Argument	Function	Module
trans_data	Transmits data from SCI_0	Transfer routine
Rev_data[0–2]	Stores SCI_0 receive data	Receive routine

### (3) On-Chip Register Descriptions

Table 5 lists the on-chip registers used in the task example. The set values shown are the values used in the task example and differ from the initial settings.

**Table 5 On-Chip Register Descriptions**

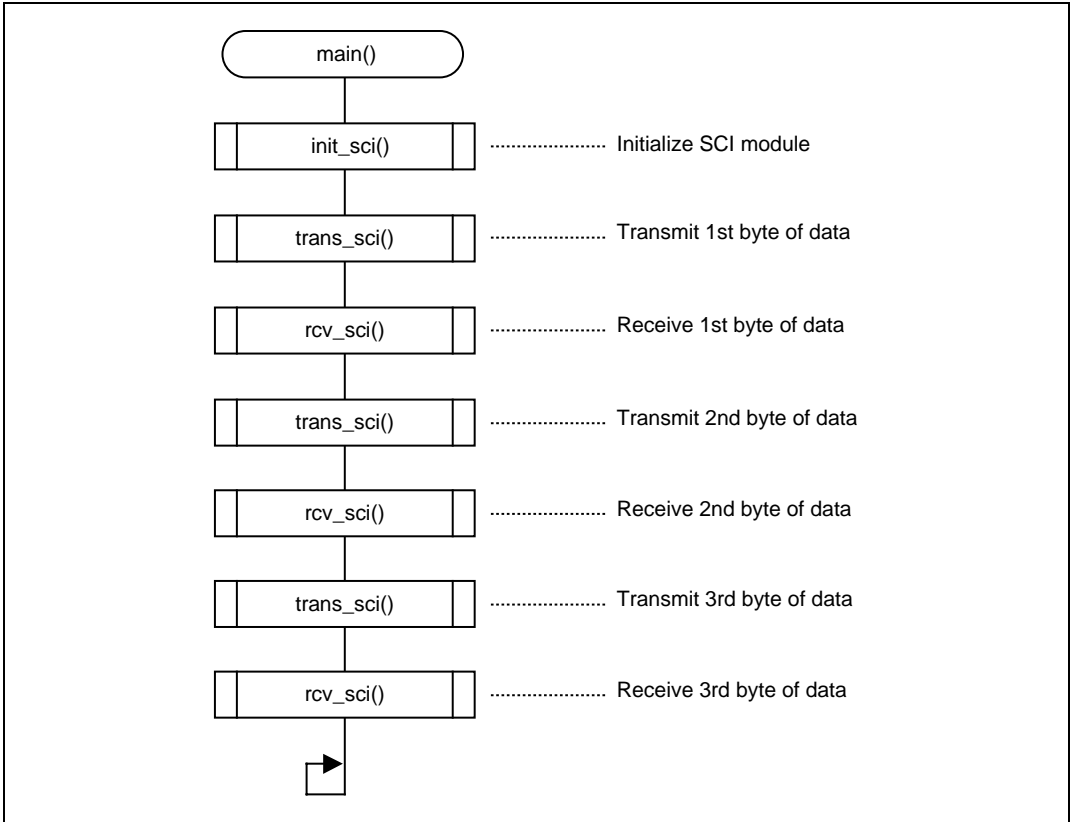
Register		Set Value	Function
Bit			
MSTCR1	MSTP16	0	Module standby control register 1 SCI0 standby control bit Standby cancelled when MSTP16 = 0
SCR_0		H'70	Serial control register 0 (SCI_0) Transmit and receive control, interrupt control, transmit and receive clock source control
	TIE	0	Transmit interrupt enable TXI interrupt requests enabled when set to 1
	RIE	1	Receive interrupt enable RXI and ERI interrupt requests enabled when set to 1
	TE	1	Transmit enable Transmit operations enabled when set to 1
	RE	1	Receive enable Receive operations enabled when set to 1
	MPIE	0	Multiprocessor interrupt enable (In asynchronous mode, enabled when MP = 1 in SMR) In the task example, disabled because MP = 0
	TEIE	0	Transmit end interrupt enable TEI interrupt requests enabled when set to 1
	CKE1	0	Clock enable 1, 0
	CKE2	0	Selects clock source and SCK pin function In the task example, clock source is on-chip clock and SCK pin is not used
SMR_0		H'00	Serial mode register 0 Selects communication format and the clock source for on-chip baud rate generator
	C/A	1	Communication mode Synchronous mode when cleared to 0
	CHR	0	Character length (enabled in asynchronous mode only) 8-bit transmission and reception when 0
	PE	0	Parity enable (enabled in asynchronous mode only) No-parity transmission and reception when 0
	O/E	0	Parity mode (enabled in asynchronous mode when PE = 1) (In this example PE = 0 and this bit is disabled)
	STOP	0	Stop bit length (enabled in asynchronous mode only) 1-stop-bit transmission and reception when 0

Register	Bit	Set Value	Function
SMR_0	MP	0	Multiprocessor mode (enabled in asynchronous mode only) Multiprocessor communication disabled when 0
	CKS1	0	Clock select 1, 0
	CKS2	0	When value is 00, P $\phi$ clock selected using on-chip baud rate generator as clock source
BRR_0		H'40	Bit rate register 0 8-bit register for adjusting bit rate
SDCR_0		H'F2	Serial direction control register 0 DIR bit (bit 3) selects LSB-first or MSB-first In task example, DIR = 0 (LSB-first)
SSR_0		H'xx	Serial status register 0 Comprises SCI1 status flag and transmit and receive multiprocessor bits Only 0 may be written to the status flag, to clear it
	TDRE	*	Transmit data register empty (status flag)
	RDRF	*	Receive data register full (status flag)
	ORER	*	Overrun error (status flag)
	FER	*	Framing error (status flag)
	PER	*	Parity error (status flag)
	TEND	*	Transmit end (status flag)
	MPB	0	Multiprocessor bit
	MPBT	0	Multiprocessor bit transfer
PACRL2	PA2MD1	0	Port A control register L2
	PA2MD0	1	Function setting for port A multiplex pin (SCK0)
	PA1MD1	0	Port A control register L2
	PA1MD0	1	Function setting for port A multiplex pin (TXD0)
	PA0MD1	0	Port A control register L2
	PA0MD0	1	Function setting for port A multiplex pin (RXD0)

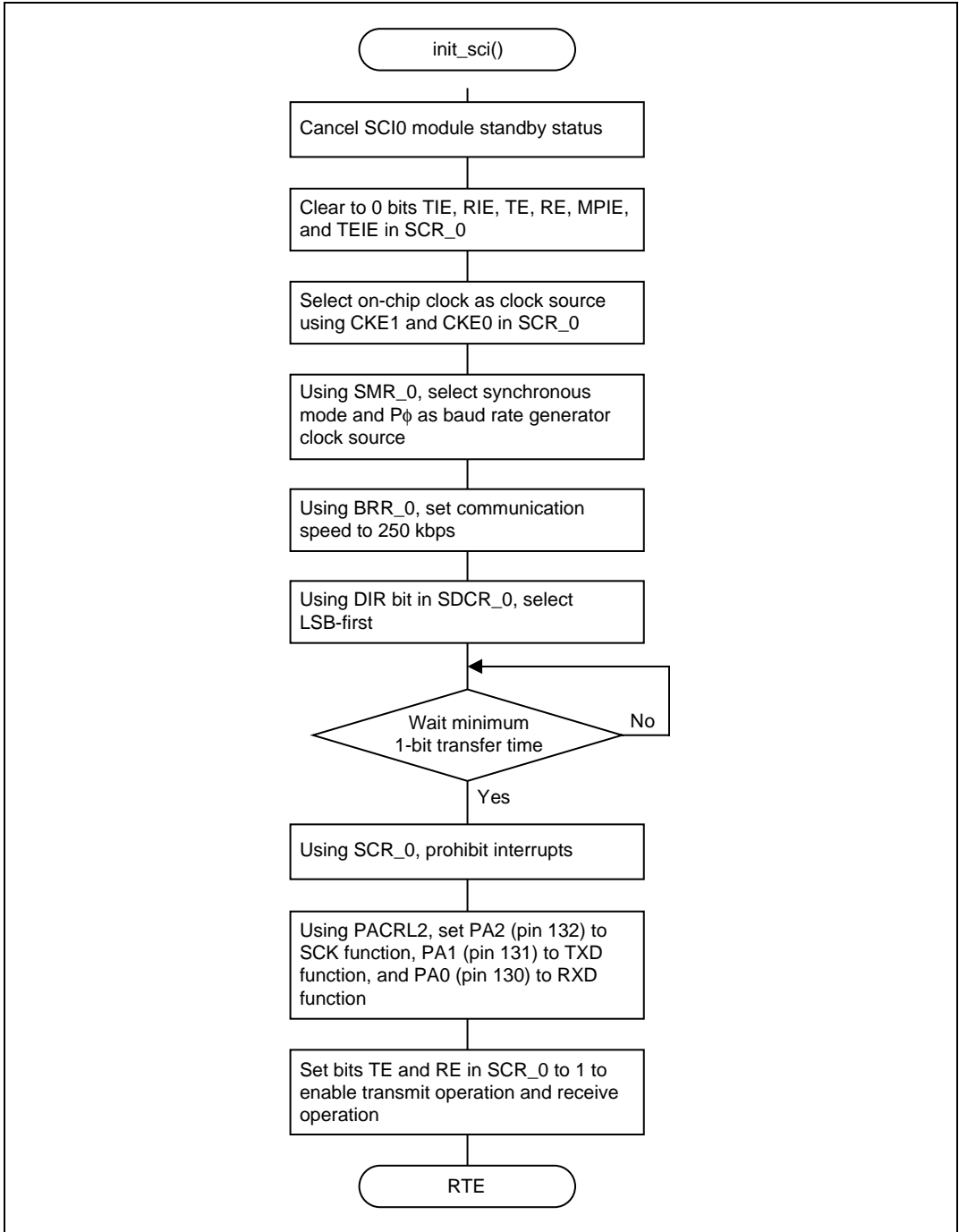
\*: Can only be cleared to 0. Setting to 1 is performed by hardware.

## 5. Flowcharts

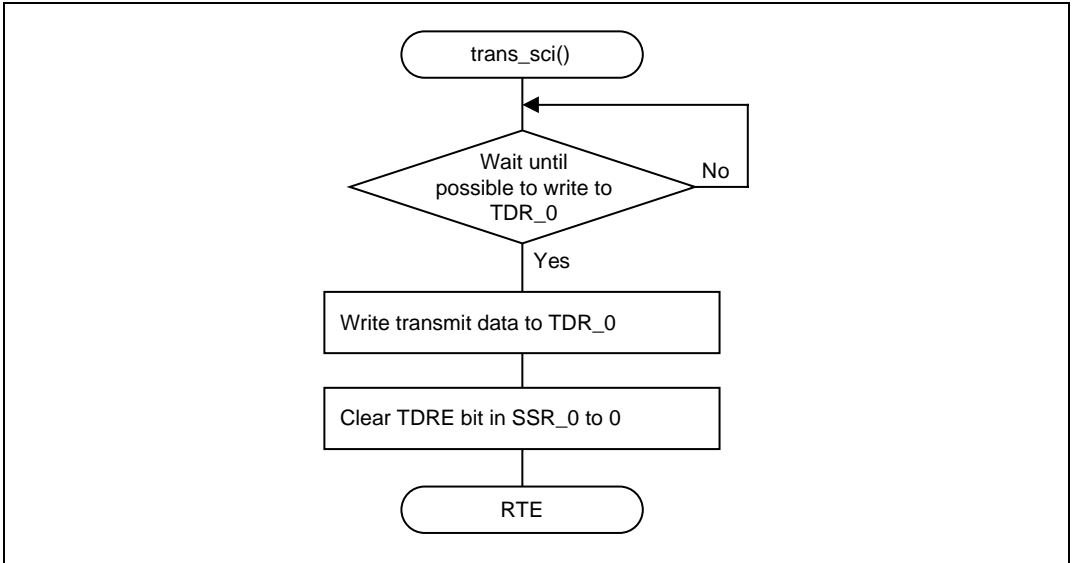
### (1) Main Routine



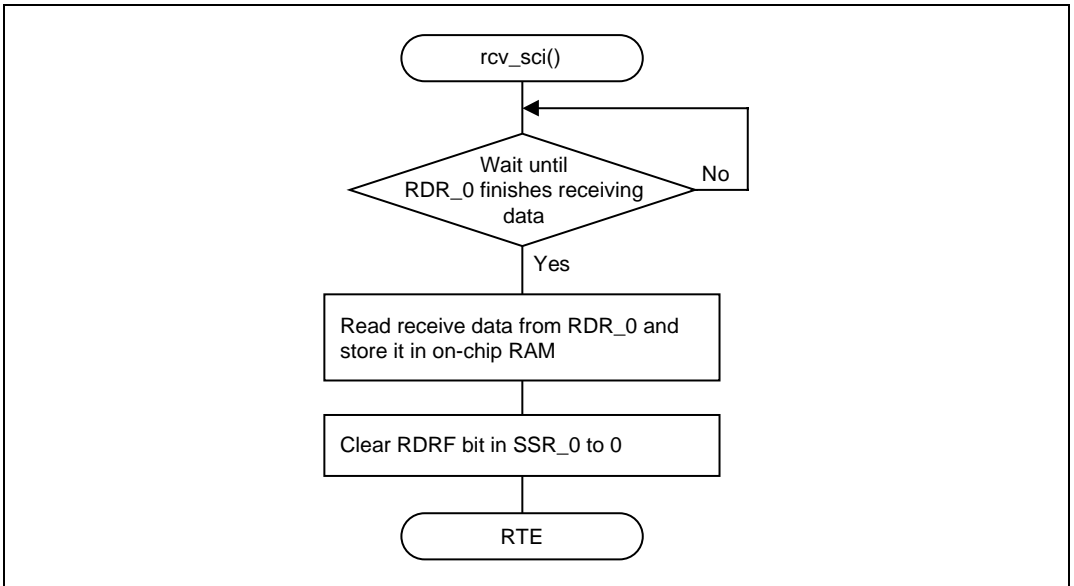
(2) SCI1 Initialize Routine



(3) Data Transfer Routine



(4) Data Receive Routine



## 6. Program Listing

```

/*****/
/* SH7145F Application Note */
/* */
/* Function */
/* :SCIO */
/* */
/* External input clock :12.5MHz */
/* Internal CPU clock :50MHz */
/* Internal peripheral clock :25MHz */
/* */
/* Written :2003/9 Rev.1.0 */
/*****/

#include "iodefine.h"
#include <machine.h>

/*----- Symbol Definition -----*/

#define COUNT 3

#define TRANS_DATA_1 0x61
#define TRANS_DATA_2 0x62
#define TRANS_DATA_3 0x63

/*----- Function Definition -----*/
void main(void);

void init_sci(void);
void trans_sci(char c);
unsigned char rcv_sci(unsigned char);

void err_int(void);
void dummy_f(void);

/*----- RAM allocation Definition -----*/

volatile unsigned char Rev_data[COUNT];

/*****/
/* main Program */
/*****/
void main( void )
{
    unsigned char i = 0;

    init_sci();          /* Initialize SCI */

    trans_sci(TRANS_DATA_1);
    i = rcv_sci(i);
}

```



```

trans_sci(TRANS_DATA_2);
i = rcv_sci(i);

trans_sci(TRANS_DATA_3);
i = rcv_sci(i);

while(1);          /* LOOP          */
}
/*****
Function  : init_sci
Operation : Initialize serial (sci0, scil)
          sci0 : Synchronous transmit operation
*****/
void init_sci(void)
{
    unsigned long i;

    P_STBY.MSTCR1.BIT.MSTP16 = 0; /* disable SCIO standby mode */

    /* Initialize SCI          */
    P_SCI0.SCR_0.BYTE &= 0x03; /* clear TIE,RIE,TE,RE,MPIE,TEIE */
    P_SCI0.SCR_0.BIT.CKE = 0; /* clock:internal,SCK:output */
    P_SCI0.SMR_0.BYTE = 0x80; /* Clock synchronous mode */
    /* CA = 1;          */ /* Clock synchronous mode */

    P_SCI0.BRR_0 = 24; /* 250kbps@25MHz(Peripheral) */
    P_SCI0.SDCR_0.BIT.DIR = 0; /* LSB first send */

    for( i=0; i < 0x0300 ; i++); /* Wait lbit */

    /* Initialize SCIO PORT          */
    P_PORTA.PACRL2.BIT.PA2MD = 1; /* set SCK0(PA2:132pin@SH7145) */
    P_PORTA.PACRL2.BIT.PA1MD = 1; /* set TXD0(PA1:131pin@SH7145) */
    P_PORTA.PACRL2.BIT.PA0MD = 1; /* set RXD0(PA0:130pin@SH7145) */

    P_PORTA.PAIORL.BIT.PA2IOR = 1; /* SCK0 Output */

    P_SCI0.SCR_0.BYTE = 0x30; /* TE=RE=1,Transmit Receive Enable(SCIO) */
}

/*****
/* Function      : trans_sci          */
/* Operation     : Write 1 character to serial output */
/* Argument      : c                  */
/* Value returned : None              */
*****/
void trans_sci(char c )
{
    while(!(P_SCI0.SSR_0.BYTE & 0x80)){ /*wait until data can be written to TDR*/

```

```

    ;
}

P_SCI0.TDR_0 = (unsigned char)c;      /* Write data to TDR          */
P_SCI0.SSR_0.BYTE &= 0x7F;          /* Clear flag, transmit      */
}

/*****
/* Function      : rcv_sci          */
/* Operation    : Store receive data in on-chip RAM          */
/* Argument     : rev_count        */
/* Value returned : rev_count      */
*****/
unsigned char rcv_sci(unsigned char rev_count)
{
    while(P_SCI0.SSR_0.BIT.RDRF == 0); /* Wait until reception is finished */

    Rev_data[rev_count] = P_SCI0.RDR_0; /* get receive data                */

    P_SCI0.SSR_0.BIT.RDRF = 0;         /* Clear RDRF                      */

    rev_count++;                       /* Increment storage address        */

    return(rev_count);
}

/*****
                Interrupt handling
*****/
#pragma interrupt(err_int)
void err_int(void)
{
    if(P_SCI0.SSR_0.BIT.ORER == 1){    /* Overrun error                  */
        P_SCI0.SSR_0.BIT.ORER = 0;    /* OREr flag clear                */
    }
}

#pragma interrupt(dummy_f)
void dummy_f(void)
{
    /* Other Interrupt */
}

```

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